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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
Jian-Ru Lin	07/26/2012
Shin-Syong Huang	07/26/2012

RECEIVING PARTY DATA

Name:	Realtek Semiconductor Corp.	
Street Address:	2 Innovation Rd. II, Science Park	
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State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13561063

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Total Attachments: 2 source=1427442#page1.tif source=1427442#page2.tif

PATENT REEL: 028668 FRAME: 0294 13E610

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNOR	(S) (Inventors):		
Name:	Jian-Ru Lin	Nationality: TW	
Name:	Shin-Syong Huang	Nationality: TW	
Hereby sells, a	ssigns and transfers to		
ASSIGNEE(S):		
Name:	Realtek Semiconductor Corp.		
Address:	2 Innovation Rd. II, Science Park, HsinChu 30076, Taiwan, R.O.C.		
any and all im	provements which are disclosed CH CIRCUIT, SAMPLING SWITCH	GNEE the entire right, title, and interest in and to in the invention entitled: H CIRCUIT AND SWITCH CAPACITOR	
Which is fou	nd in :		
(a)	a) U.S. patent application executed on even date		
(b)	U.S. patent application executed	d on	
(c)	U.S. application serial no		
(d)	patent no.	issued	
(e)	International application no		

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this JUL 2 6 2012 (Date of signing). (铸發明人粉必發著上列目期。)

(Type name of inventor)

Signature of INVENTOR

Jian-Ru Lin

Jiun-Ru Lin.

Shin-Syong Huang

Shin-Syong Huang

Assignment, Page 2 of 2

F#NPO-P0002E-US1 DSC0-100U014484

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PATENT

REEL: 028668 FRAME: 0296